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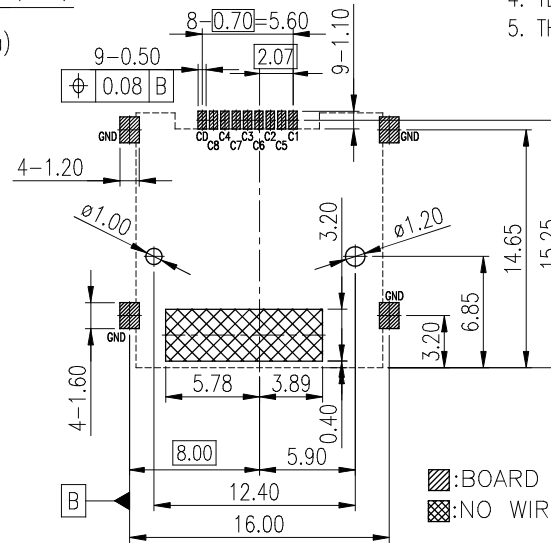
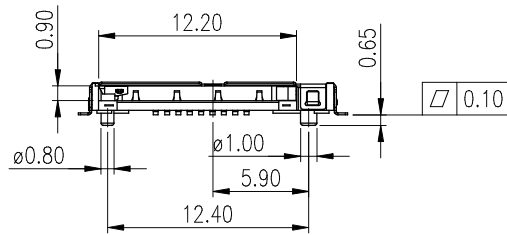
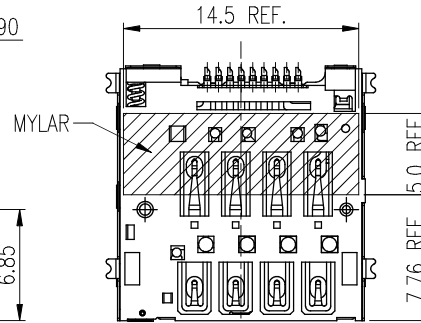
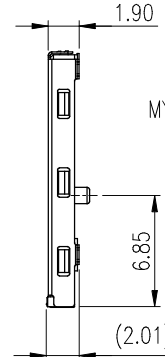
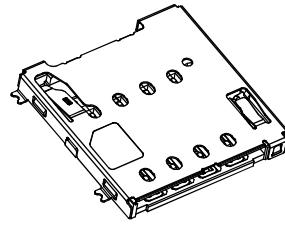
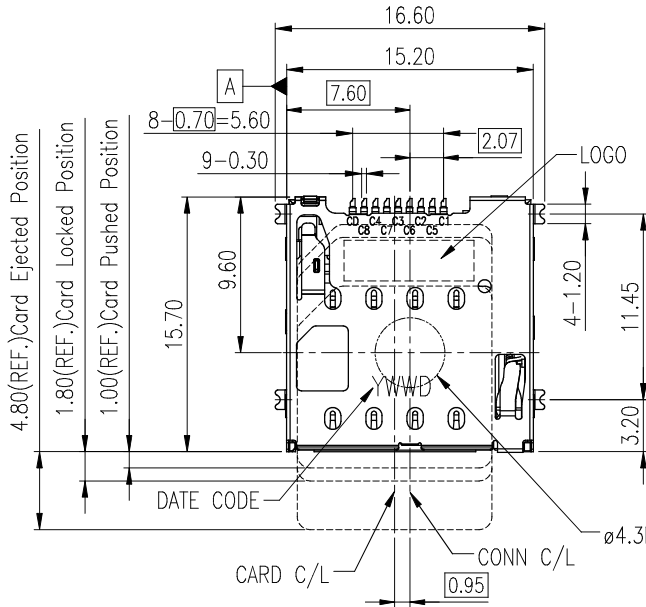
The marking on this product doesn't contain environmental hazardous materials per Material Specification SS-00259 for Sony GP compliant or per directive 2011/65/EU for RoHS compliant.



ORIGINAL



REVISIONS				
SYM	ECN No.	DESCRIPTION	DATE	APPROVED
A	NE-18103	RELEASE REVISION	06/05/2018	Roger Tsai



NOTES:

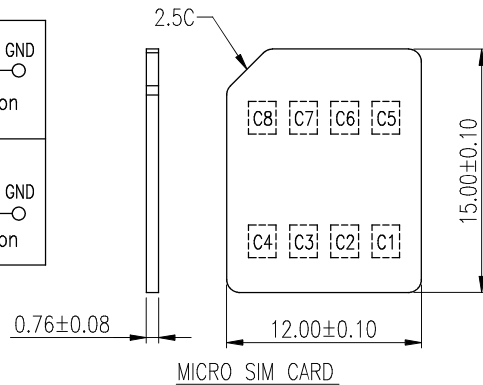
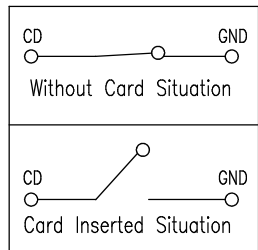
- MATERIAL:
HOUSING: HIGH TEMPERATURE THERMAL PLASTIC LCP, UL94V-0, BLACK.
TERMINAL: COPPER ALLOY.
SWITCH: COPPER ALLOY.
SHELL: COPPER ALLOY.
- FINISH:
TERMINAL:
CONTACT AREA: SELECTIVE GOLD PLATING THICKNESS MIN.;
SOLDERING AREA: GOLD FLASH PLATING THICKNESS MIN.;
UNDER PLATING: NICKEL PLATING 50u" THICKNESS MIN. OVERALL.
SWITCH:
CONTACT AREA: GOLD FLASH PLATING ON CONTACT AREA;
SOLDERING AREA: GOLD FLASH PLATING ON SOLDER AREA;
UNDER PLATING: NICKEL PLATING 50u" THICKNESS MIN. OVERALL.
SHELL: GOLD FLASH ON SOLDERING PAD.
NICKEL PLATING 50u" THICKNESS MIN. OVERALL.
- PRODUCT SPECIFICATION REFER TO : PS-7676.
- TEST SUMMARY REFER TO : TS-7676-001.
- THIS PRODUCT IS HALOGEN-FREE PRODUCT.

PIN ASSIGNMENT

C1	VCC
C2	RST
C3	CLK
C4	RESERVED
C5	GND
C6	VPP
C7	I/O
C8	RESERVED

PART NO. G85B2161 X 14 X HHR

CONTACT FINISH: 0: GOLD FLASH, 1: 15u" GOLD, 2: 30u" GOLD
PACKAGING: 1: TRAY, 2: TAPE & REEL



RECOMMEND P.C.B.OARD LAYOUT
PCB TOLERANCE:±0.05

TOLERANCE	APPROVALS	DATE	TITLE	
X. ±0.30	DRAWN Karen Su	06/05/2018	MICRO SIM CARD CONNECTOR	
X.X ±0.20	CHECKED Aqua Chou	06/05/2018	8 POS., WITH POST, SMT, 1.9H	
X.XXX ±0.10	APPROVED Roger Tsai	06/05/2018	NORMAL CLOSE, PUSH/PUSH TYPE	
ANGULAR ±1°	DWG TYPE CUST DWG	PROJECT CODE OTHER	UNIT mm	SIZE A3
UNLESS OTHERWISE SPECIFIED			SCALE NA	SHEET 1 OF 2

■:BOARD PAD
▨:NO WIRING AREA

PART No. G85B2161X14XHHR
DWG No. G85B2161X14XHHR

TITLE: MICRO SIM CARD CONNECTOR
REV. A

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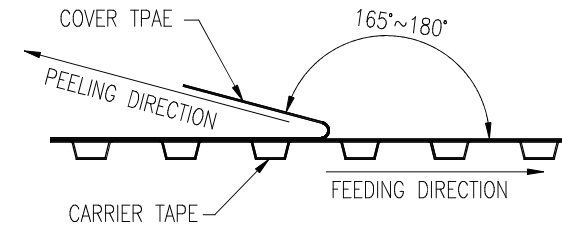
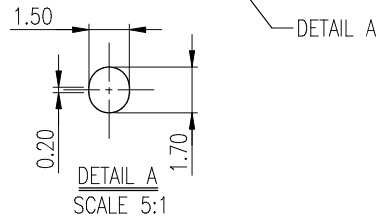
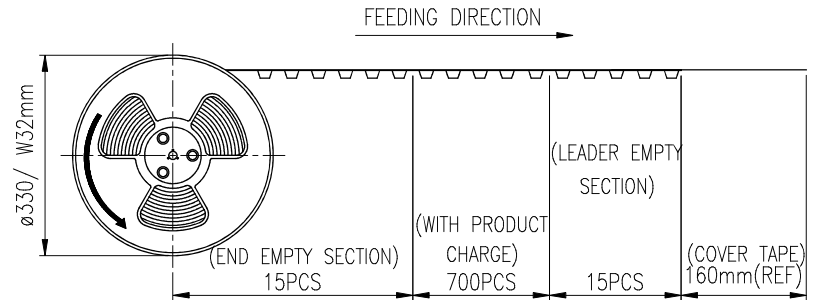
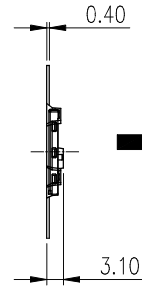
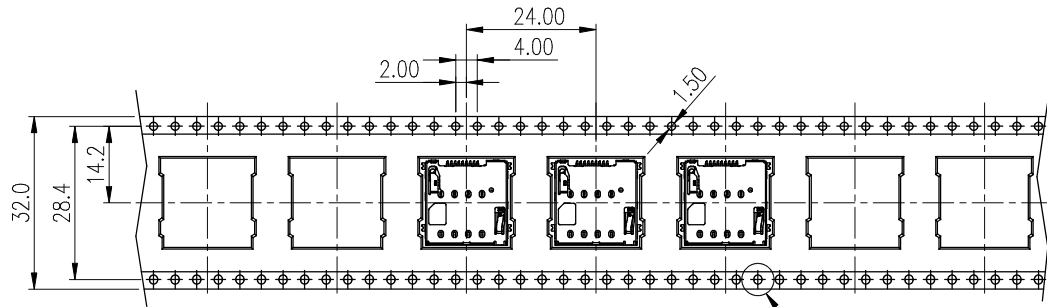
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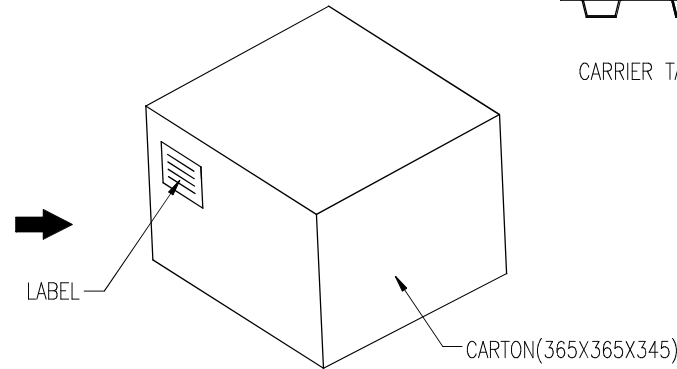
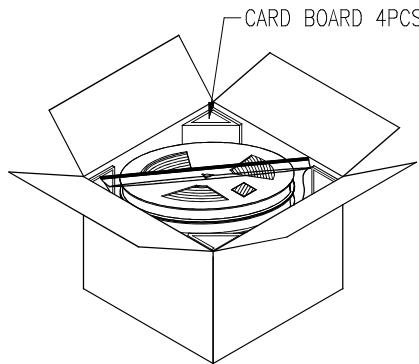
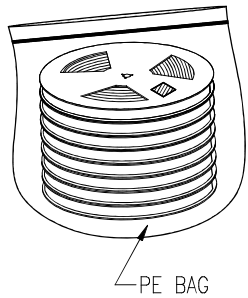
ORIGINAL



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SYM	ECN No.	DESCRIPTION	DATE	APPROVED
A	NE-18103	RELEASE REVISION	06/05/2018	Roger Tsai



TOTAL 8 REEL



NOTES:

- CARRIER TAPE MEET EIA-481 STANDARD
- PACKING QUANTITY:
 - 700 PCS PRODUCT/REEL.
 - 8 PCS REEL/CARTON.
 - 5600 PCS PRODUCT/CARTON.
- N.W.: 3.0KGS
- G.W.: 8.3 KGS
- PEELING FORCE: 0.1N~1.3N

TOLERANCE	APPROVALS	DATE	TITLE		PART No.	
X. ±0.30	DRAWN Karen Su	06/05/2018	MICRO SIM CARD CONNECTOR 8 POS., WITH POST, SMT, 1.9H NORMAL CLOSE, PUSH/PUSH TYPE		Amphenol® Amphenol Corporation Amphenol Taiwan Corporation	
X.X ±0.20	CHECKED Aqua Chou	06/05/2018				
X.XXX ±0.10	APPROVED Roger Tsai	06/05/2018				
ANGULAR ±1°	DWG TYPE CUST DWG	PROJECT CODE OTHER	UNIT mm	SIZE A3	G85B2161X14XHHR	
UNLESS OTHERWISE SPECIFIED			SCALE NA	SHEET 2 OF 2	G85B2161X14XHHR	
					REV. A	